

Part Number: KCPSC04-105

Hyper Red

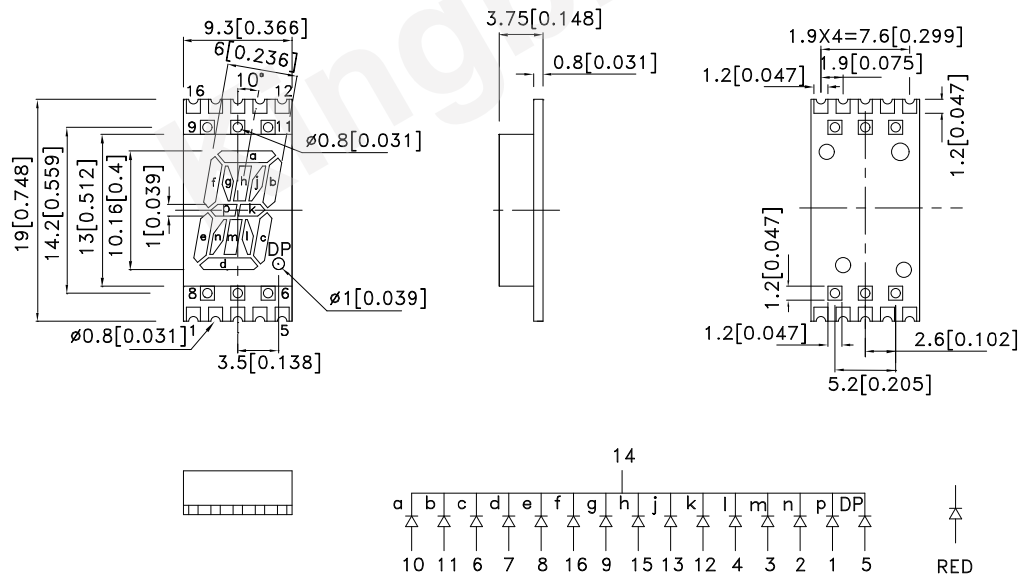
### Features

- 0.4 inch character height.
- Low current operation.
- High contrast and light output.
- Categorized for luminous intensity.
- Mechanically rugged.
- Gray face, white segment.
- Package : 400pcs / reel.
- Moisture sensitivity level : level 2a.
- RoHS compliant.

### Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

### Package Dimensions& Internal Circuit Diagram



#### Notes:

1. All dimensions are in millimeters (inches), Tolerance is  $\pm 0.25$  (0.01") unless otherwise noted.
2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
3. The gap between the reflector and PCB shall not exceed 0.25mm



## Selection Guide

| Part No.    | Emitting Color (Material) | Lens Type      | Iv (ucd) [1]<br>@ 10mA |       | Description                          |
|-------------|---------------------------|----------------|------------------------|-------|--------------------------------------|
|             |                           |                | Min.                   | Typ.  |                                      |
| KCPSC04-105 | Hyper Red (AlGaInP)       | White Diffused | 14000                  | 36000 | Common Cathode, Rt.<br>Hand Decimal. |
|             |                           |                | *3600                  | *8300 |                                      |

### Notes:

1. Luminous intensity / luminous Flux: +/-15%.

\* Luminous intensity value is traceable to CIE127-2007 standards.

## Electrical / Optical Characteristics at TA=25°C

| Symbol                | Parameter                | Emitting Color | Typ. | Max. | Units | Test Conditions |
|-----------------------|--------------------------|----------------|------|------|-------|-----------------|
| $\lambda_{peak}$      | Peak Wavelength          | Hyper Red      | 645  |      | nm    | IF=10mA         |
| $\lambda_D$ [1]       | Dominant Wavelength      | Hyper Red      | 630  |      | nm    | IF=10mA         |
| $\Delta\lambda_{1/2}$ | Spectral Line Half-width | Hyper Red      | 28   |      | nm    | IF=10mA         |
| C                     | Capacitance              | Hyper Red      | 35   |      | pF    | VF=0V;f=1MHz    |
| VF [2]                | Forward Voltage          | Hyper Red      | 1.85 | 2.5  | V     | IF=10mA         |
| IR                    | Reverse Current          | Hyper Red      |      | 10   | uA    | VR=5V           |

### Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

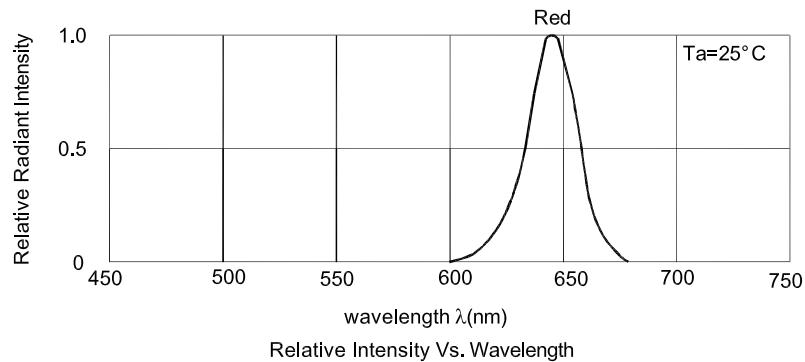
## Absolute Maximum Ratings at TA=25°C

| Parameter                       | Values         | Units |
|---------------------------------|----------------|-------|
| Power dissipation               | 75             | mW    |
| DC Forward Current              | 30             | mA    |
| Peak Forward Current [1]        | 185            | mA    |
| Reverse Voltage                 | 5              | V     |
| Operating / Storage Temperature | -40°C To +85°C |       |

### Notes:

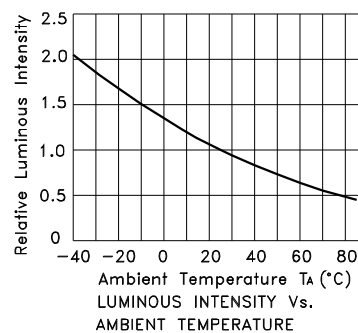
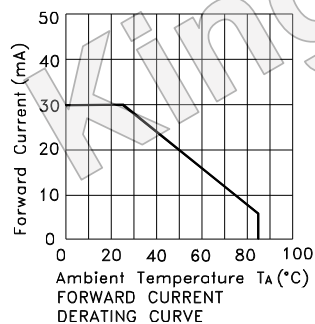
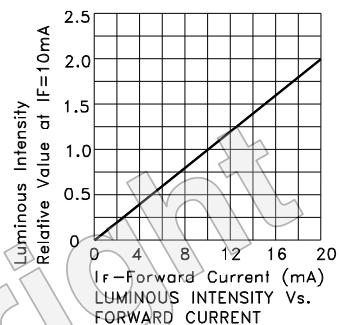
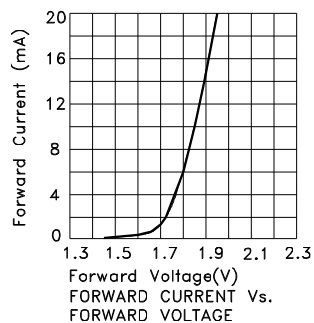
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



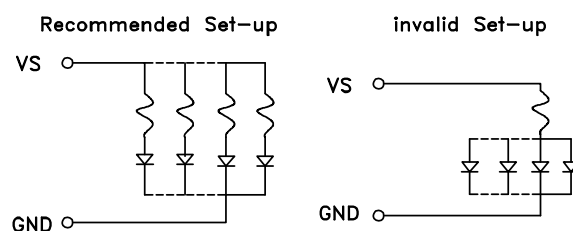
## Hyper Red

### KCPSC04-105



## CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



## KCPSC04-105

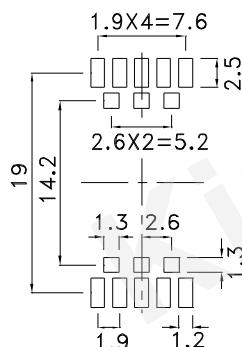
### Reflow Soldering Profile For Lead-free SMT Process.



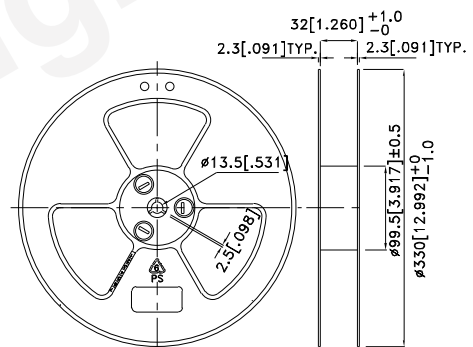
#### NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

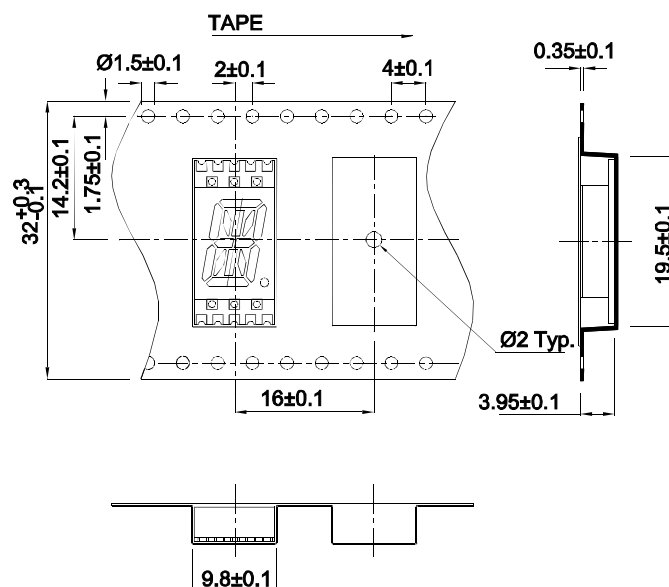
### Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.15)



### Reel Dimension

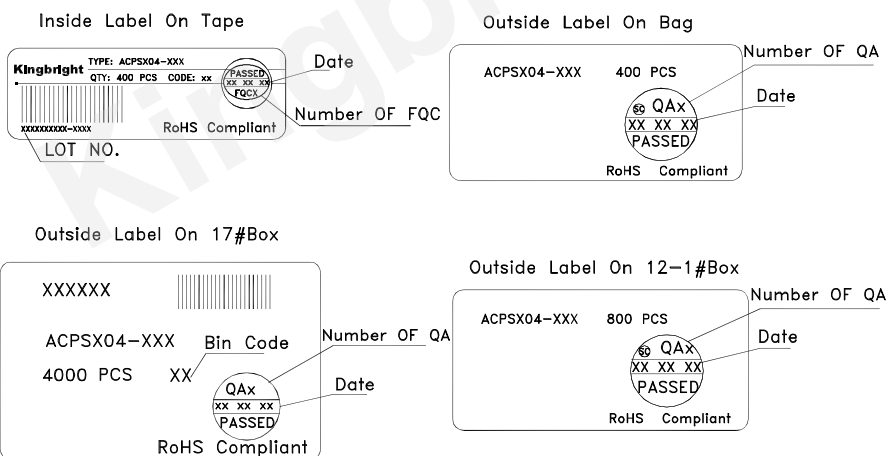
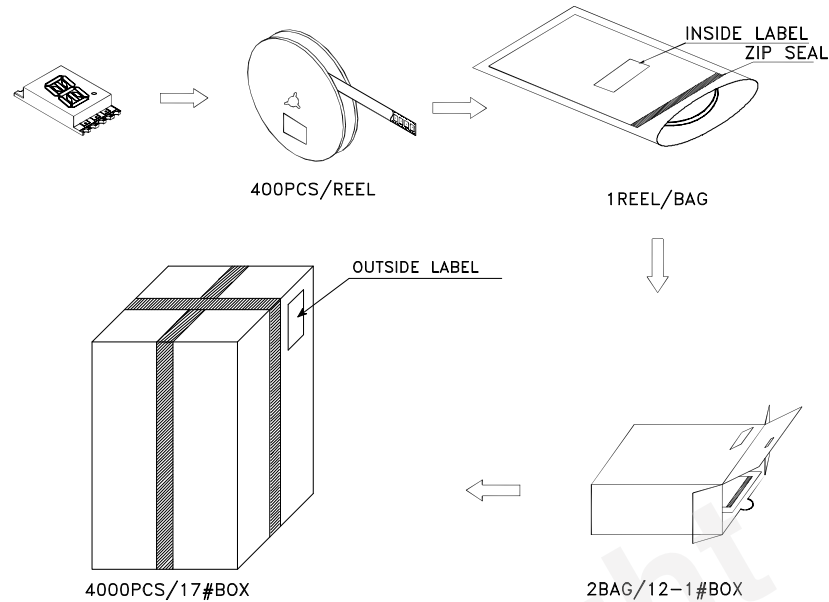


### Tape Specifications



## PACKING & LABEL SPECIFICATIONS

## KCPSC04-105



### Terms and conditions for the usage of this document

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
6. All design applications should refer to Kingbright application notes available at [http://www.kingbright.com/application\\_notes](http://www.kingbright.com/application_notes)